<b>Notification Number:</b>	otification Number: 20220715001.0 Notification Date: July 26, 2022					
Title:   Datasheet for TPS54331						
Customer Contact: PCN Manager				De	pt: Quality Services	
Change Type:						
Assembly Site		Design			Wafer Bump Site	
Assembly Process				Ц	Wafer Bump Material	
Assembly Materials		Part number change		<u>     </u>	Wafer Bump Process	
<ul> <li>Mechanical Specifica</li> <li>Packing/Shipping/Lab</li> </ul>				$\mathbb{H}$	Wafer Fab Site Wafer Fab Materials	
		ling   📙 Test Process		H	Wafer Fab Process	
Notification Details						
Description of Change:						
Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details. TEXAS						
INSTRUMENTS SLVS839G – JULY 2008 – REVISED JULY 2022						
Changes from Revision F (October 2014) to Revision G (July 2022) Page						
<ul> <li>Updated the numbering format for tables, figures and cross-references throughout the document</li></ul>						
The datasheet number will be changing. Device Family			Change From:		Change To:	
TPS54331		SLV	SLVS839F		SLVS839G	
These changes may be reviewed at the datasheet links provided. https://www.ti.com/product/TPS54331 Error! Bookmark not defined.						
Reason for Change:						
To accurately reflect device characteristics.						
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):						
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.						
Changes to product identification resulting from this notification:						
None.						
Product Affected:						
			TPS54331DDA		TPS54331DDAR	
TPS54331D	TPS54331D-P					
TPS54331DG4	TPS54331DR		TPS54331DR-P		TPS54331DRG4	
TPS54331DRG4						
For questions regarding t local Field Sales Represer		s can b	e sent to the co	ontac	ct shown below or your	

Location	E-Mail
WW PCN Team	PCN ww admin team@list.ti.com

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